# **BGA616**

Silicon Germanium Broadband MMIC Amplifier

**RF & Protection Devices** 



#### Edition 2011-09-02

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# **BGA616, Silicon Germanium Broadband MMIC Amplifier**

**Revision History: 2011-09-02, Rev. 2.1** 

Previous Version: 2003-04-16

Page	Subjects (major changes since last revision)				
All	New Chip Version with integrated ESD protection				
5	Electrical Characteristics slightly changed				
7-8	Figures updated				
All	Document layout change				

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Data Sheet 3 Rev. 2.1, 2011-09-02



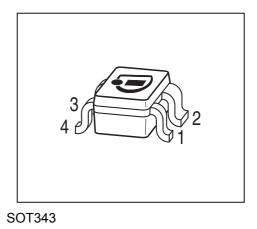
#### Silicon Germanium Broadband MMIC Amplifier

# 1 Silicon Germanium Broadband MMIC Amplifier

#### **Feature**

- Cascadable 50 Ω-gain block
- 3 dB-bandwidth: DC to 2.7 GHz with 19.0 dB typical gain at 1.0 GHz
- Compression point P<sub>-1dB</sub> = 18 dBm at 2.0 GHz
- Noise figure  $F_{50\Omega}$  = 2.60 dB at 2.0 GHz
- · Absolute stable
- 70 GHz  $f_T$  Silicon Germanium technology
- 1 kV HBM ESD protection (Pin-to-Pin)
- Pb-free (RoHS compliant) package





#### **Applications**

- Driver amplifier for GSM/PCS/SCDMA/UMTS
- Broadband amplifier for SAT-TV & LNBs
- Broadband amplifier for CATV

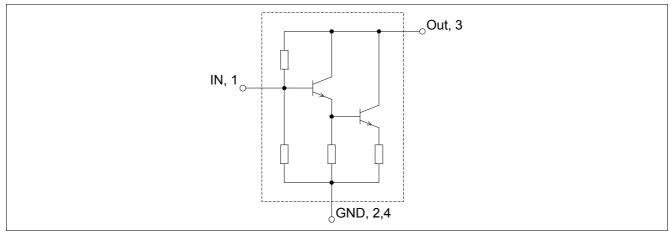


Figure 1 Pin connection

#### **Description**

The BGA616 is a broadband matched general purpose MMIC amplifier in a Darlington configuration. It is optimized for a typical supply current of 60 mA.

The BGA616 is based on Infineon Technologies' B7HF Silicon Germanium technology.

Туре	Package	Marking
BGA616	SOT343	BPs

Note: **ESD:** Electrostatic discharge sensitive device, observe handling precaution



#### **Electrical Characteristics**

### **Maximum Ratings**

Table 1 Maximum ratings

Symbol	Limit Value	Unit	
$V_{D}$	4.5	V	
$I_{D}$	80	mA	
$I_{in}$	0.7	mA	
$P_{in}$	10	dBm	
$P_{tot}$	360	mW	
$T_{J}$	150	°C	
$T_{A}$	-65 150	°C	
$T_{STG}$	-65 150	°C	
V <sub>ESD</sub>	1000	V	
	$V_{\mathrm{D}}$ $I_{\mathrm{D}}$ $I_{\mathrm{in}}$ $P_{\mathrm{in}}$ $P_{\mathrm{tot}}$ $T_{\mathrm{J}}$ $T_{\mathrm{STG}}$	$\begin{array}{cccccccccccccccccccccccccccccccccccc$	

<sup>1)</sup> Valid for  $Z_{\rm S}$  =  $Z_{\rm L}$  = 50  $\Omega$ ,  $V_{\rm CC}$  = 6 V,  $R_{\rm Bias}$  = 33  $\Omega$ 

Note: All Voltages refer to GND-Node

#### Thermal resistance

Table 2 Thermal resistance

Parameter	Symbol	Value	Unit
Junction - soldering point <sup>1)</sup>	$R_{thJS}$	200	K/W

<sup>1)</sup> For calculation of  $R_{\mathrm{thJA}}$  please refer to Application Note Thermal Resistance

# 2 Electrical Characteristics

Electrical characteristics at  $T_{\rm A}$  = 25 °C (measured in test circuit specified in **Figure 2**)  $V_{\rm CC}$  = 6 V,  $R_{\rm Bias}$  = 33  $\Omega$ , Frequency = 2 GHz, unless otherwise specified

**Table 3** Electrical Characteristics

Parameter	Symbol	Values			Unit	Note /
		Min.	Тур.	Max.		<b>Test Condition</b>
Insertion power gain	$ S_{21} ^2$		20.0		dB	f = 0.1 GHz
			19.0		dB	f= 1 GHz
			18.0		dB	f = 2 GHz
Noise figure ( $Z_{\rm S}$ = 50 $\Omega$ )	$F_{50\Omega}$		2.2		dB	f = 0.1 GHz
			2.5		dB	f= 1 GHz
			2.6		dB	f = 2 GHz
Output power at 1 dB gain compression	$P_{ ext{-1dB}}$		18		dBm	
Output third order intercept point	OIP <sub>3</sub>		29		dBm	
Input return loss	$RL_{\sf in}$		15		dB	
Output return loss	$RL_{out}$		15		dB	
Total device current	$I_{D}$		60		mA	

<sup>2)</sup>  $T_{\rm S}$  is measured on the ground lead at the soldering point



#### **Electrical Characteristics**

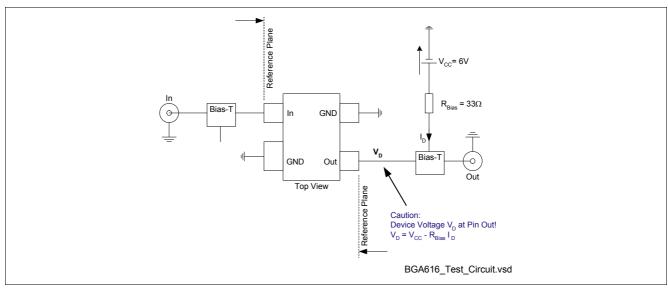
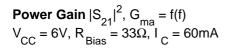
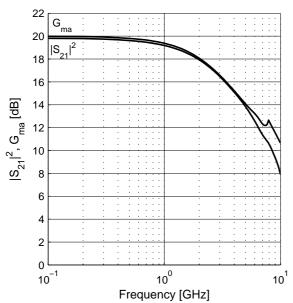


Figure 2 Test Circuit for Electrical Characteristics and S-Parameter

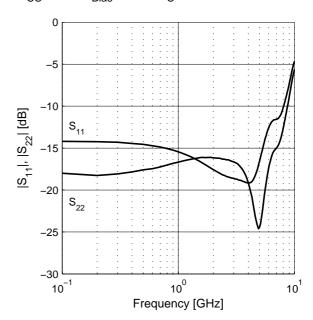
**Measured Parameters** 

# 3 Measured Parameters

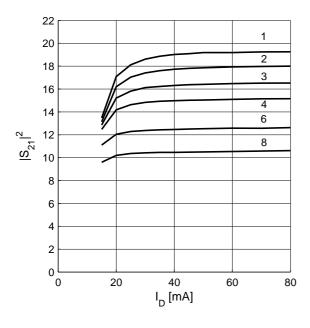




$$\begin{aligned} & \textbf{Matching} \ |S_{11}|, \ |S_{22}| = \textbf{f(f)} \\ & \textbf{V}_{CC} = \textbf{6V}, \ \textbf{R}_{Bias} = 33\Omega, \ \textbf{I}_{C} = \textbf{60mA} \end{aligned}$$

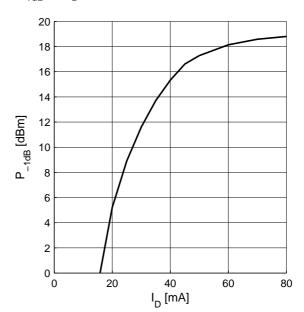


# Power Gain $|S_{21}| = f(I_D)$ f = parameter in GHz



### **Output Compression Point**

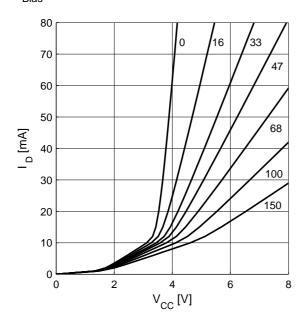
$$P_{-1dB} = f(I_D), f = 2GHz$$



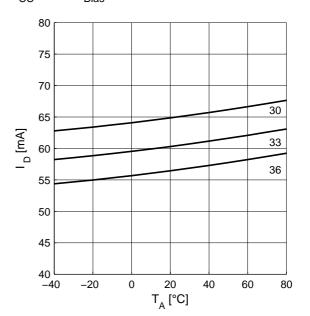


#### **Measured Parameters**

Device Current I 
$$_{\rm D}$$
 = f(V $_{\rm CC}$ ) R $_{\rm Bias}$  = parameter in Ω

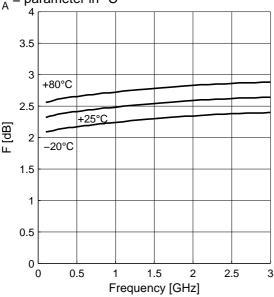


# Device Current I $_{\rm D}$ = f(T $_{\rm A}$ ) V $_{\rm CC}$ = 6V, R $_{\rm Bias}$ = parameter in Ω



### Noise figure F = f(f)

$$V_{CC} = 6V$$
,  $R_{Bias} = 33\Omega$ ,  $Z_{S} = 50\Omega$   
 $T_{A} = parameter in °C$ 





**Package Information** 

# 4 Package Information

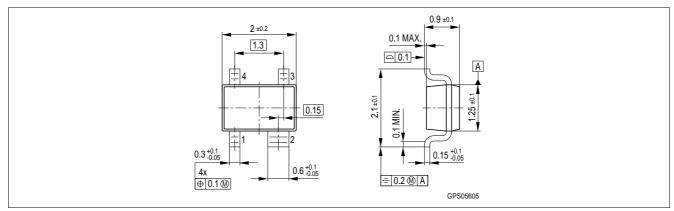


Figure 3 Package Outline SOT343

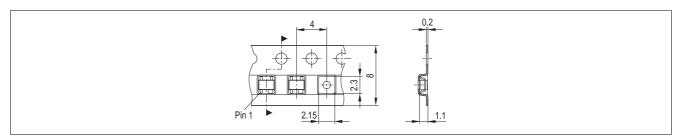


Figure 4 Tape for SOT343

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